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Evaluation of Bonding Performance of Amino Polymers Using ABES

N. A. COSTA^{1,2,3}, J. PEREIRA^{1,3}, J. FERRA², P. CRUZ², J. MARTINS^{1,4},

F. D. MAGALHÃES¹, A. MENDES¹, and L. H. CARVALHO^{1,4}

¹LEPAE, Laboratory for Process, Environmental and Energy Engineering, Faculty of Engineering, University of Porto, Porto, Portugal

²EuroResinas – Indústrias Químicas, Sines Portugal

³ARCP, Competence Network in Polymers Association, Porto, Portugal

⁴DEMad, Department of Wood Engineering, Polytechnic Institute of Viseu, Viseu, Portugal

In this paper, the use of Automated Bonding Evaluation System (ABES) for evaluation of bonding strength of wood adhesives is presented. A simple reactive model is proposed, which considers the phenomena involved during resin cure: formation of wood-resin-wood bonds. In the present study, experimental data of a standard urea-formaldehyde (UF) resin using different catalysts, phosphoric acid and ammonium sulphate, are presented and discussed. The proposed can be applied to wood adhesives, namely formaldehyde-based resins under different temperatures. The model fits well to experimental data, presenting high determination coefficient values.

KEYWORDS Adhesion by chemical bonding; Adhesives for wood; Mechanical properties of adhesives; Polymers; Wood

1. INTRODUCTION

Wood is one of the most popular building materials in the world, but prior to the emergence of wood-based panels, it had some drawbacks that made it undesirable for many projects. Wood-based panel is a general term for a variety of the different board products made of wood, which have an impressive range of engineering properties [1]. The most common wood-based panels (WBP) are particleboard (PB) and medium density fibreboard (MDF) bonded with an adhesive, usually urea-formaldehyde (UF) or melamine-urea-formaldehyde (MUF) resins [2]. WBP have a positive impact on the rule of carbon storage, due to the high incorporation of recycled wood in their composition [2]. However, boards produced with recycled wood present higher formaldehyde emissions [3]. Due to the recommendation for formaldehyde reclassification as “carcinogenic to humans” by the International Agency for Research on Cancer (IARC) published in 2006 [4], the concern about formaldehyde issues has been increased, and new regulations

have been imposed in order to reduce formaldehyde emissions from wood-based products. Facing the new guidelines, substantial efforts to develop and provide products with low emission levels were made by WBP manufacturers [5,6]. Formaldehyde release during the boards in service is caused not only by the hydrolysis of formaldehyde bonds in the polymeric structure of adhesive, but also by the liberation of free formaldehyde [7,8]. The most common strategies to reduce formaldehyde emission are: reduction of formaldehyde to amino groups molar ratio, development and optimization of new synthesis protocols, and the use of formaldehyde scavengers [9]. In the last few years, several studies have been focused on synthesis protocols of formaldehyde-based adhesives [10,11] as well as on the incorporation of reinforcing agents, such as sucrose [12] and melamine [13]. Several studies on formaldehyde scavengers were also developed with success [6,14–16], allowing them to attain emissions at solid wood level [6]. Few studies can be found regarding UF resins. Gunnells and Griffin [17] presented a catalytic system based on buffer solutions, but its higher price and lower reactivity did not convince industrial producers. Ammonium sulphate and ammonium nitrate are the most common catalysts, also called latent catalysts because, at higher temperatures, they react with formaldehyde forming sulphuric or nitric acid, decreasing pH environment and promoting the cure reaction. However, these catalysts form hexamine as a by-product [8]. Costa et al. [18] showed that hexamine contributes to formaldehyde release during the lifetime of panels. Boards produced by these authors using phosphoric acid as a catalyst (which not produce hexamine as by-product) presented lower formaldehyde emissions than boards produced with ammonium sulphate, when stored under forceful conditions. These results motivate the study for catalytic systems for UF resins.

Several techniques for the characterization of wood adhesives are available, such as gel permeation chromatography (GPC) and high-performance liquid chromatography (HPLC) [19], as well as spectroscopic techniques such as infrared (IR) [20], near infrared (NIR) [12,21,22], nuclear magnetic resonance (NMR) [20,23,24] and Raman [25], among other techniques. Unfortunately, the attempts that have been made with these techniques in order to correlate the characterization data (e.g., quantity of functional groups) and the mechanical performance of the adhesive (board internal bond strength) did not attain robust relationships. During the hot-pressing process of a WBP, it can be distinguished between the chemical curing (building up of the three-dimensional network) of the thermosetting adhesive and the mechanical forming of the bonding strength between wood and adhesive [26]. Differential scanning calorimetry (DSC) gives useful information about the adhesive “chemical cure” [27,28] allowing the estimation of the degree of chemical curing. Mechanical curing in the sense of the increase in cohesive bond strength can be monitored by thermomechanical analysis (TMA), dynamic mechanical analysis (DMA), or Automated Bonding Evaluation System (ABES) [29]. ABES [30] is a powerful and versatile technique for evaluation of “mechanical cure.” This apparatus is based on a single lap shear test, but the joint is usually small (60 to 100 mm²) and the pressing conditions such as temperature, pressing time, as well as pressure can be adjusted. The overlapped strips could be also cooled before testing in shear mode, making ABES a suitable apparatus for the determination of shear strength as a function of resin type, catalytic system, resin load, cure temperature, time, substrate, etc. in WBP research [26,31–36]. Nevertheless, ABES is a destructive test providing only one data point per test, and it cannot be used for continuous in situ processes. Studies considering adhesive characterization and bonding strength evaluation using ABES usually consider the adhesive as a mixture of resin and catalyst. In this work, ABES apparatus are used to characterize UF resins. Curing temperature, resin load, and different catalytic systems were studied (latent catalyst: ammonium sulphate and polyprotic

acid: phosphoric acid). Innovation of the model proposed is the reduction of the number of trials needed for the characterization, which allows the preservation of adhesive properties during all the experiment. A mathematical model is proposed to predict the bond strength development, a possible kinetic model is also presented, and the kinetic constants for UF resin in the presence of different catalytic systems are calculated.

2. MATERIAL AND METHODS

2.1. Materials

UF resin with a F/U molar ratio of 1.07 was provided by EuroResinas – Indústrias Químicas, S. A. (Sines, Portugal). This resin was previously characterized in terms of bond strength in WBP and formaldehyde content in a previous work [18]. Beech (*Fagussylvatica* L.) veneer strips for ABES tests were supplied by Sonae Indústria, PCDM S. A. (Mangualde, Portugal). Catalysts used were provided by Euroresinas (ammonium sulphate) and purchased from Panreac (phosphoric acid 85% solution, analytical grade).

2.2. Methods

Tests with ABES apparatus (Fig. 1) were made using beech veneers strips 0.5 mm thick, 20 mm wide, and 117 mm in length. For each test, two veneer strips were glued together with an overlap of 5 mm.

Beech strips were stored at a controlled temperature (25°C) and relative humidity (65%) prior cutting. Prior to testing, strips were prepared using a die cutter supplied by Adhesive Evaluation Systems (Corvallis, Oregon). Adherent pairs were mounted in the system with an overlapping area of 100 mm².

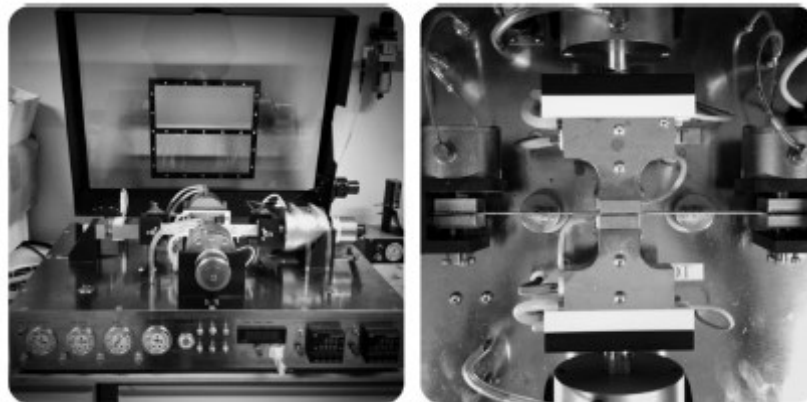


Figure 1. ABES equipment: a) front view and b) top view

3. RESULTS AND DISCUSSION

3.1. Effect of Resin Load on Shear Strength

ABES tries to simulate the bond strength development that occurs inside the mat during the hot-pressing of a WBP. The shear strength of a glue joint depends on the number of bonds formed between wood and the thermo-setting resin. These bonds are formed during the resin cure.

Therefore, resin cure depends on the temperature attained inside the mat, while the maximum shear strength is dependent on the number of wood-resin-wood (w-r-w) bonds. The number of w-r-w is intrinsically related with the amount of resin per area (resin load). Figure 2a shows the evolution of shear strength with increasing of temperature for a resin load of 80 g/m². It is visible that, as expected, shear strength increases faster at higher temperatures. However, it is observed that the maximum shear strength was reached after 350 seconds at 95°C, while at 85°C it is only reached after 600 seconds of pressing time. Figure 2b shows the shear strength according to the resin load for a temperature of 115°C using 3 wt.% of ammonium sulfate as a catalyst and pressed during 350 seconds. Although for these tests, species with micro-structural uniformity and a certain level of hardness and density are recommended (as in the case of beech), small differences in shear strength could be related to the inherent variability of wood. Despite the variability of raw materials, differences observed in the maximum shear strength could be related to the thermal damage kinetics of adhesive bonds [8,36].

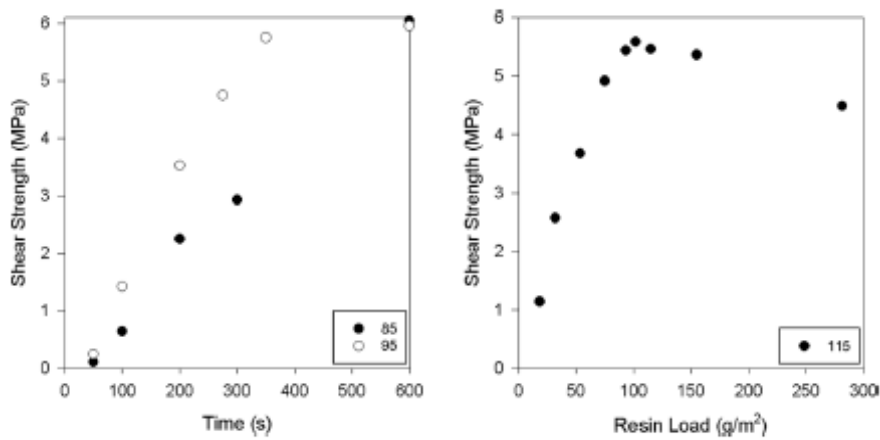


Figure 2. Shear strength of a UF resin measured in ABES: a) influence of temperature and b) influence of resin load (temperatures shown are in Celsius degrees).

3.2. Models to Predict Shear Strength of ABES Data

MATHEMATICAL MODEL

ABES apparatus is easy to use; however, a careful treatment of data is needed in order to obtain a complete characterization of an adhesive, considering the curing rate, as a function of temperature, as well as the determination of gel time and kinetic constant. Equation (1) represents a simple empirical model, based on a hyperbolic tangent function, where shear strength (σ) is function of time (t), that can be used to describe the experimental curves. In the argument of the hyperbolic function there is a time constant, which is the time needed to reach half of the maximum shear strength, called t_0 , which is related to the gel time of the resin. The variable λ is called dynamic cure constant and could be associated with the reaction kinetic constant.

$$\sigma = \frac{\sigma_{max}}{1 + A} \left(A + \tanh \left[\frac{t - t_0}{\lambda} \right] \right), \text{ where } A = \tanh \left(\frac{t_0}{\lambda} \right) \quad (1)$$

This mathematical model can be easily linearized to obtain the values of

these two parameters (t_0 and λ) by Eq. (2). Maximum shear strength (α_{max}) is defined as the maximum value obtained in ABES tests.

KINETIC MODEL

The previous model can be proven to be a representation of a simple kinetic model based on the assumption of two reactions: an apparent first order reaction (k_1) and an apparent second order reaction (k_2). The proposed model intends to be a simple kinetic description of the bond formation mechanism, considering the reaction of resin with two molecules of formaldehyde and consequent bonding to wood strips ($w-r-w$). The second reaction represents the reaction of two molecules of formaldehyde with the ($w-r-w$) linkage, forming a “double bond linkage” ($w=r=w$), forming a stronger structure.

Equation 2 describes the rate of formation of the wood-resin-wood bonds. C is proportional to α and is related to the concentration of formed wood-resin bonds.

$$\frac{dC}{dt} = k_1 C_F + k_2 C C_F, \text{ where } C_F = C_0^* - C \text{ and } \sigma \propto C. \quad (2)$$

Figure 3 shows ABES experimental data of a standard UF resin evaluated under different temperatures (between 85 and 115°C) using different catalysts: phosphoric acid (Fig. 3a) and ammonium sulfate (Fig. 3b). When ammonium sulphate is used at 105°C, a significant deviation from the model is observed. The fact that this deviation is only observed for this latent catalyst, close to the water boiling temperature, may indicate that the ammonium sulfate equilibrium reaction with formaldehyde to form sulfuric acid is displaced to the left side by excess water.

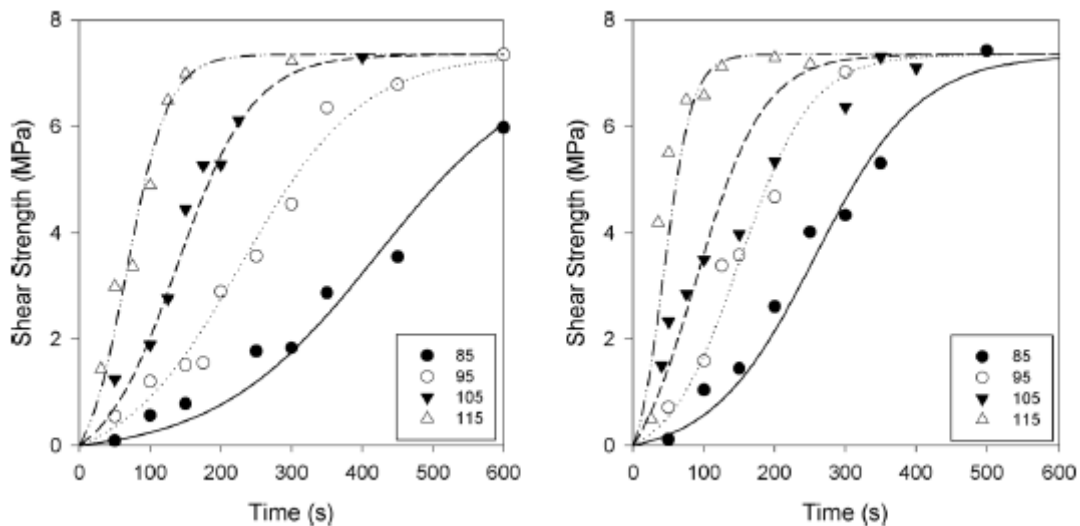


Figure 3. Experimental data and reactive model of UF resin catalyzed with: a) phosphoric acid and b) ammonium sulfate (temperatures shown are in Celsius degrees).

Table 1 shows the values of model parameters obtained by fitting the proposed model to the experimental data. The maximum shear strength (α_{max}), which should be function of the strength of a single bond, was equal for all series (7.3 MPa). The coefficients of determination,

as well as the significance level, are also presented in Table 1 in order to evaluate the predictive ability of the proposed model.

Table1. Optimized variables of the proposed model

Catalyst	Phosphoric acid				Ammonium sulfate			
	85	95	105	115	85	95	105	115
Temperature	85	95	105	115	85	95	105	115
t_0	419.9	235.6	138.9	66.6	259.5	157.2	113.9	31.1
λ	217.8	125.8	81.9	65.2	131.7	103.7	119.2	68.5
R^2	0.966 (***)	0.991 (***)	0.994 (***)	0.994 (***)	0.973 (***)	0.990 (***)	0.992 (***)	0.967 (***)

Significance level – (***) = 0.1%.

4. CONCLUSIONS

ABES apparatus is an excellent technique for bonding evaluation. Shear strength is extremely dependent of the resin load in the glue joint. Increasing the resin load increases the maximum shear strength. However, above 100 g per square meter, increasing resin load led to an adverse effect on shear strength. The ideal resin load for bonding evaluation is around 100 g/m².

The proposed model with three parameters adjusts the experimental data well, supporting that the proposed reactive scheme can represent the bonding development during the resin cure. The model proposed is robust, being an alternative method for “mechanical cure” characterization of wood adhesives.

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